

# 4V Drive Nch MOSFET

## RSR025N05

### ●Structure

Silicon N-channel MOSFET

### ●Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Drive circuits can be simple.
- 4) Parallel use is easy.

### ●Application

Switching

### ●Packaging specifications

Type	Package	Taping
	Code	TL
	Basic ordering unit (pieces)	3000
RSR025N05		○

### ●Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Limits	Unit	
Drain-source voltage	V <sub>DSS</sub>	45	V	
Gate-source voltage	V <sub>GSS</sub>	±20	V	
Drain current	Continuous	I <sub>D</sub>	±2.5	A
	Pulsed	I <sub>DP</sub> *1	±10	A
Source current (Body Diode)	Continuous	I <sub>S</sub>	0.8	A
	Pulsed	I <sub>SP</sub> *1	10	A
Power dissipation	P <sub>D</sub> *2	1.0	W	
Channel temperature	T <sub>ch</sub>	150	°C	
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C	

\*1 Pw ≤ 10μs, Duty cycle ≤ 1%

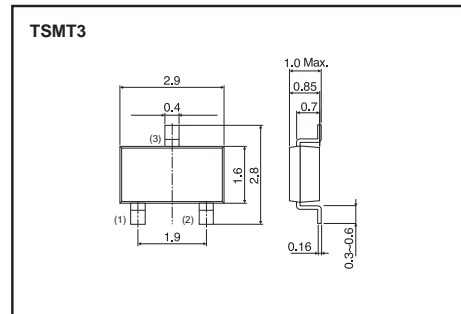
\*2 Mounted on a ceramic board

### ●Thermal resistance

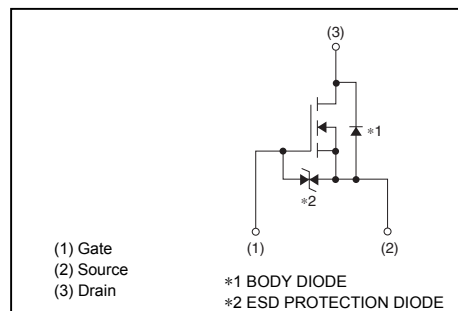
Parameter	Symbol	Limits	Unit
Channel to Ambient	R <sub>th(ch-a)</sub> *	125	°C / W

\* Mounted on a ceramic board

### ●Dimensions (Unit : mm)



### ●Inner circuit



●Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I <sub>GSS</sub>	-	-	±10	μA	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	45	-	-	V	I <sub>D</sub> =1mA, V <sub>GS</sub> =0V
Zero gate voltage drain current	I <sub>DSS</sub>	-	-	1	μA	V <sub>DS</sub> =45V, V <sub>GS</sub> =0V
Gate threshold voltage	V <sub>GS(th)</sub>	1.0	-	3.0	V	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA
Static drain-source on-state resistance	R <sub>DS(on)</sub> <sup>*</sup>	-	70	100	mΩ	I <sub>D</sub> =2.5A, V <sub>GS</sub> =10V
		-	95	150		I <sub>D</sub> =2.5A, V <sub>GS</sub> =4.5V
		-	105	160		I <sub>D</sub> =2.5A, V <sub>GS</sub> =4.0V
Forward transfer admittance	Y <sub>fs</sub>   <sup>*</sup>	2.0	-	-	S	I <sub>D</sub> =2.5A, V <sub>DS</sub> =10V
Input capacitance	C <sub>iss</sub>	-	260	-	pF	V <sub>DS</sub> =10V
Output capacitance	C <sub>oss</sub>	-	90	-	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	C <sub>rss</sub>	-	30	-	pF	f=1MHz
Turn-on delay time	t <sub>d(on)</sub> <sup>*</sup>	-	9	-	ns	I <sub>D</sub> =1.25A, V <sub>DD</sub> ≒25V
Rise time	t <sub>r</sub> <sup>*</sup>	-	11	-	ns	V <sub>GS</sub> =10V
Turn-off delay time	t <sub>d(off)</sub> <sup>*</sup>	-	25	-	ns	R <sub>L</sub> =20Ω
Fall time	t <sub>f</sub> <sup>*</sup>	-	8	-	ns	R <sub>G</sub> =10Ω
Total gate charge	Q <sub>g</sub> <sup>*</sup>	-	3.6	-	nC	V <sub>DD</sub> ≒25V
Gate-source charge	Q <sub>gs</sub> <sup>*</sup>	-	1.5	-	nC	I <sub>D</sub> =2.5A,
Gate-drain charge	Q <sub>gd</sub> <sup>*</sup>	-	0.8	-	nC	V <sub>GS</sub> =5V

\*Pulsed

●Body diode characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward Voltage	V <sub>SD</sub> <sup>*</sup>	-	-	1.2	V	I <sub>s</sub> =2.5A, V <sub>GS</sub> =0V

\*Pulsed

●Electrical characteristic curves (Ta=25°C)

Fig.1 Typical Output Characteristics ( I )

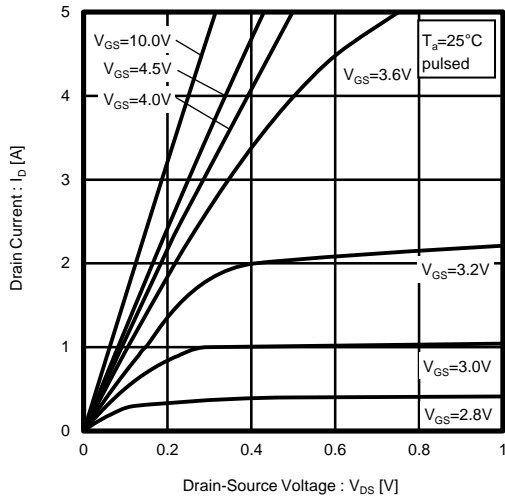


Fig.2 Typical Output Characteristics ( II )

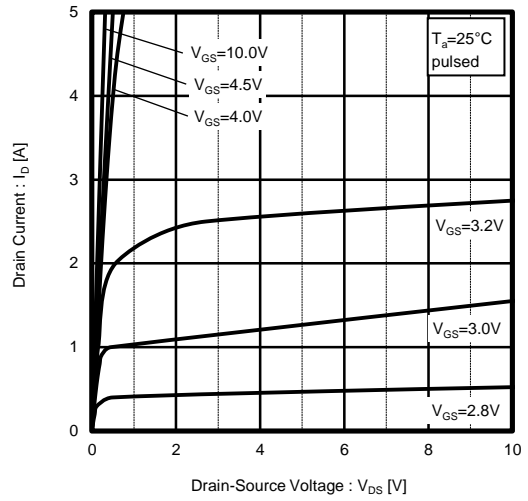


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

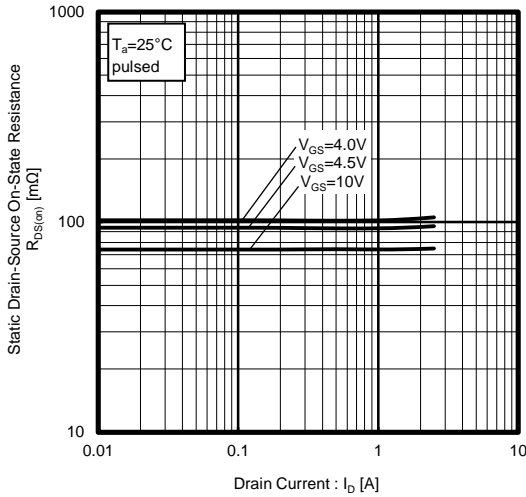


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

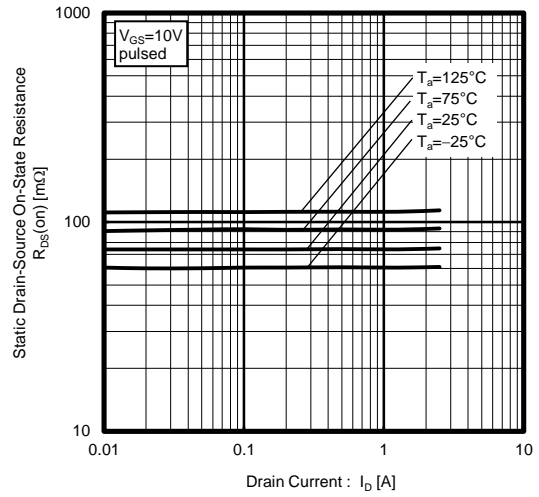


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

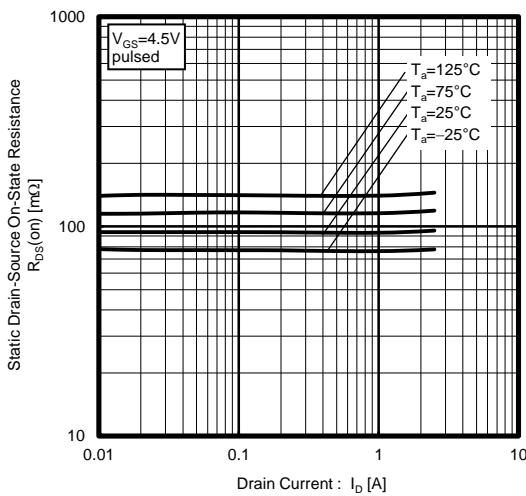


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current

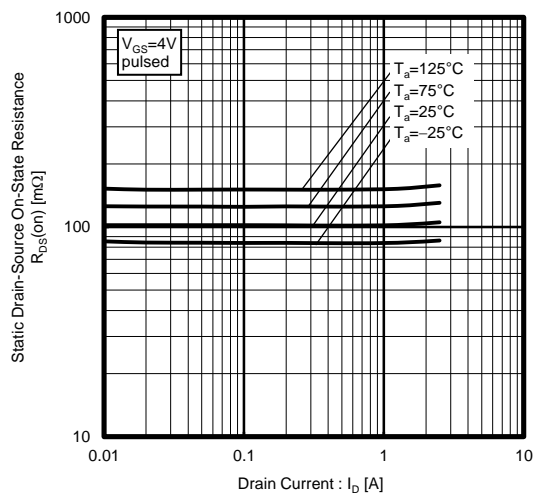


Fig.7 Forward Transfer Admittance vs. Drain Current

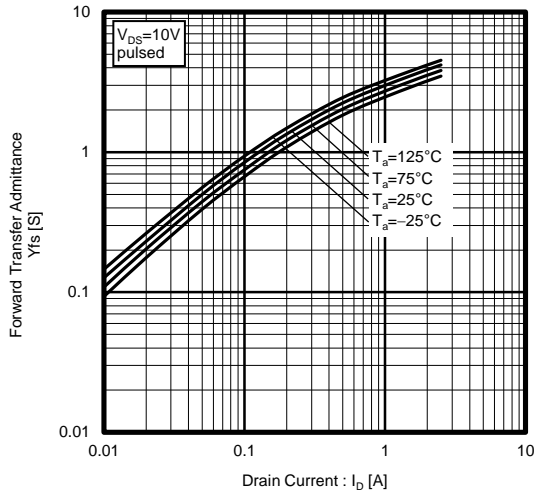


Fig.8 Typical Transfer Characteristics

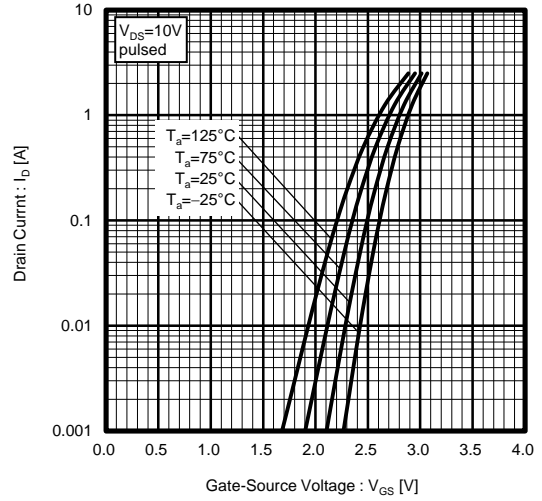


Fig.9 Source Current vs. Source-Drain Voltage

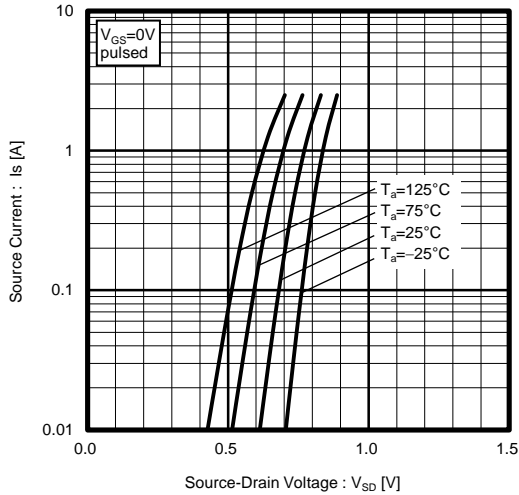


Fig.10 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

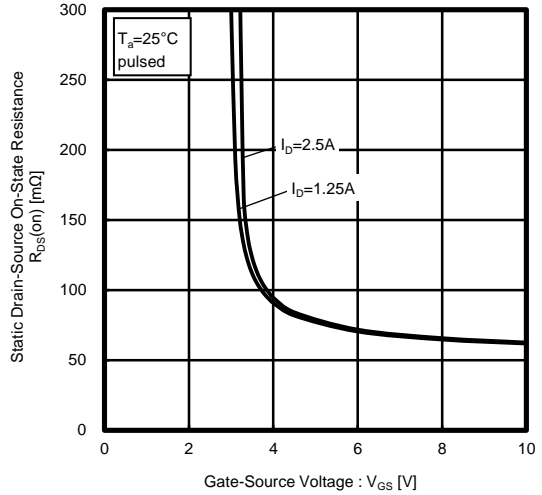


Fig.11 Switching Characteristics

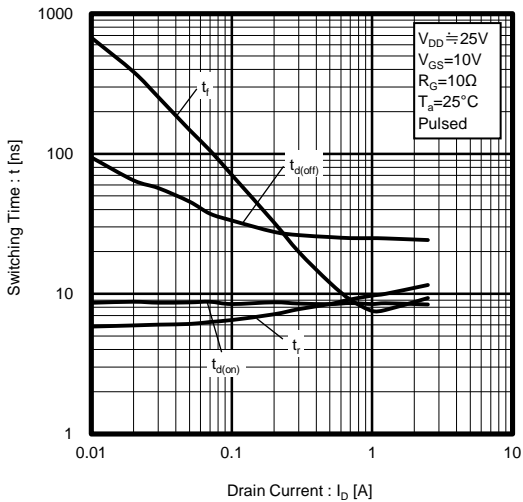


Fig.12 Dynamic Input Characteristics

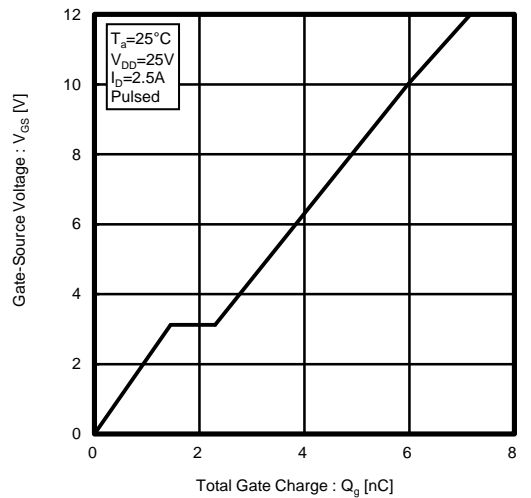


Fig.13 Typical Capacitance vs. Drain-Source Voltage

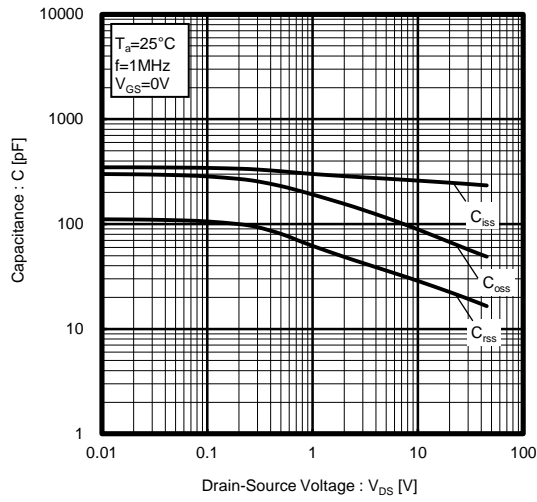


Fig.14 Maximum Safe Operating Area

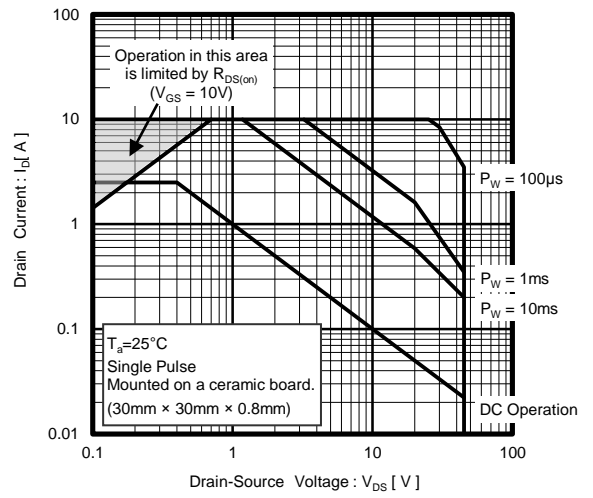
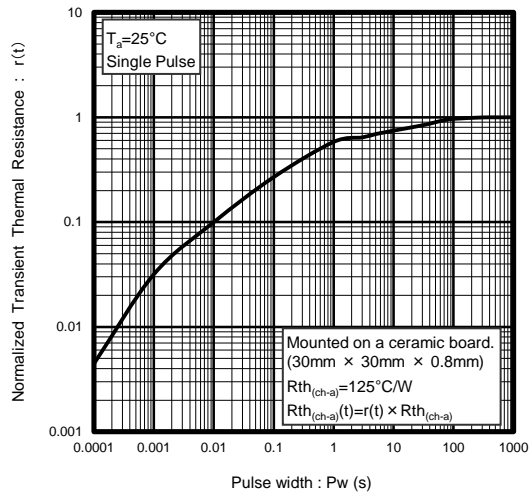


Fig.15 Normalized Transient Thermal Resistance v.s. Pulse Width



● Measurement circuits

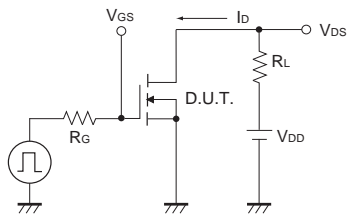


Fig.1-1 Switching Time Measurement Circuit

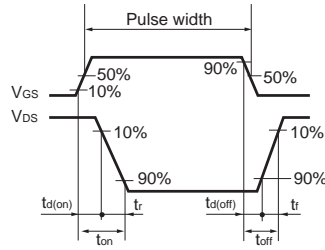


Fig.1-2 Switching Waveforms

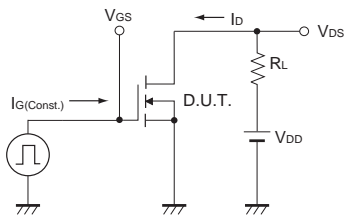


Fig.2-1 Gate Charge Measurement Circuit

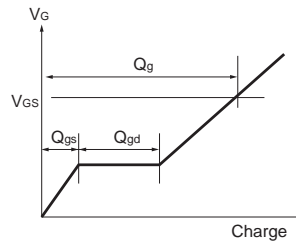


Fig.2-2 Gate Charge Waveform

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